

Contact Dimensions:

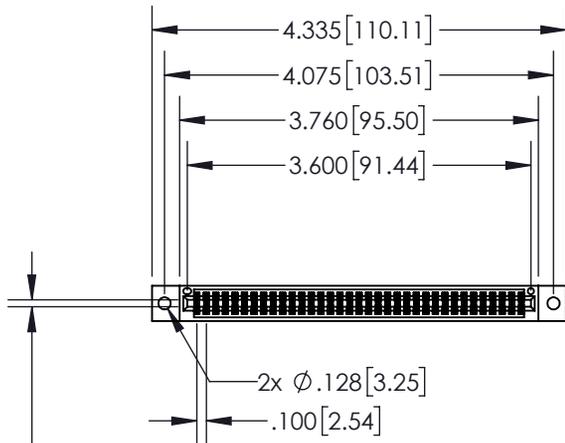
**542-Wire Wrap .025 Sq.(0.64 Sq.) - Tail LG=.645(16.38)
 .100 (2.54) Contact Spacing x .200 (5.08) Row Spacing**

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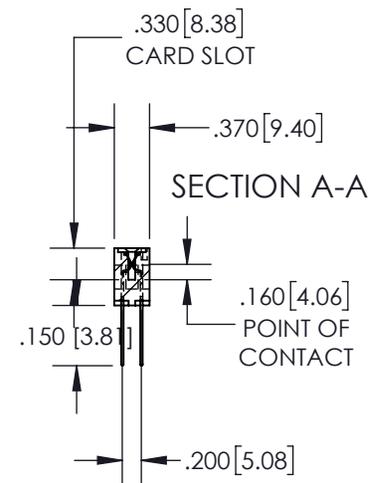
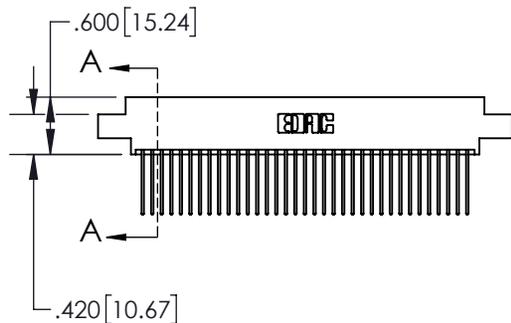


ISSUE NUMBER

ORIGINAL



CARD SLOT ACCEPTS
 .054" [1.37] TO .070" [1.78]
 THICK PCB



- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

**845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR
 PART NUMBER: 895-070-542-802**



EDAC INC
 TORONTO, ONTARIO
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ACAD REFERENCE NO. 845-ENG-MASTER

DRAWN: R.STA.MONICA DATE MAY.16/2017

CHECKED: DATE:

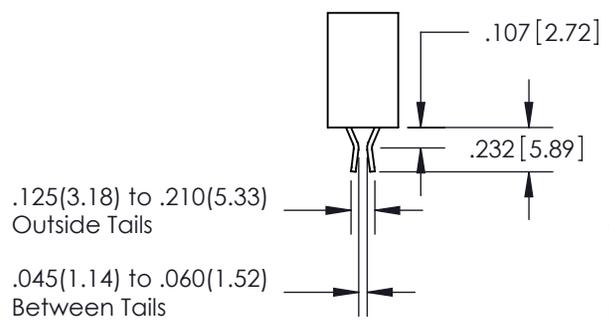
SCALE: 1:2 SHEET 1 OF 2

DRAWING NUMBER 845-ENG-MASTER ISSUE 1

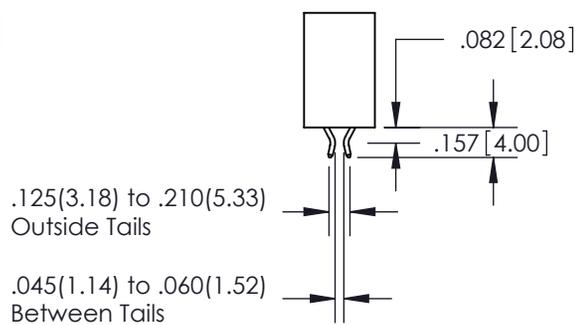
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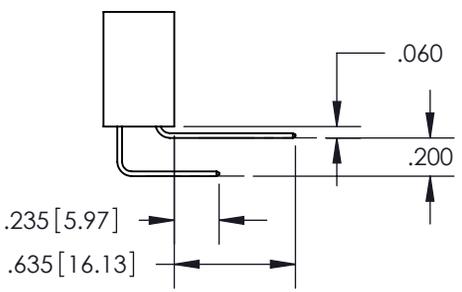
ISSUE NUMBER
ORIGINAL



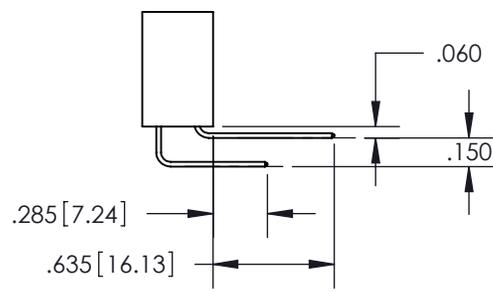
Contact Code 555



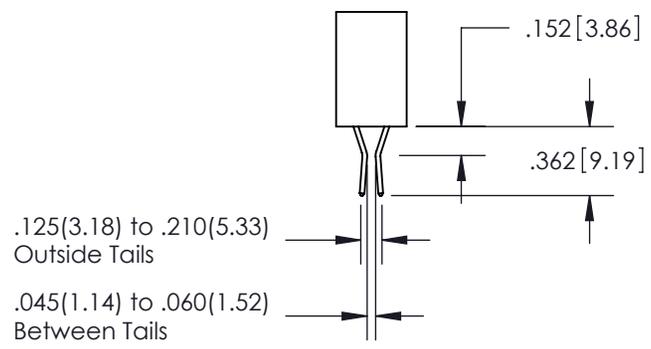
Contact Code 556



Contact Code 558



Contact Code 559



Contact Code 560

- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0
- DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL: COPPER ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

**845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR
CONTACT CODE 555,556,558,559,560 DIMENSIONS**

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CHECKED:	DATE:
SCALE: 1:1	SHEET 2 OF 2
DRAWING NUMBER 845-ENG-MASTER	ISSUE 1